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219.40232X00

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): Sarah E. KIM et al.  
Serial No.: 10/077,967  
Filed: February 20, 2002  
For: A PROCESS OF VERTICALLY STACKING MULTIPLE WAFERS  
SUPPORTING DIFFERENT ACTIVE INTEGRATED CIRCUIT (IC)  
DEVICES  
Group: 2822

**INFORMATION DISCLOSURE STATEMENT**  
**UNDER 37 CFR §1.97 & §1.98**

Assistant Commissioner of Patents  
Washington, D.C. 20231

April 16, 2002

Sir:

In the matter of the above-identified application, Applicants are submitting herewith copies of the documents listed in the attached form equivalent to Form PTO-1449 for the Examiner's consideration.

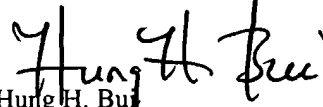
This information disclosure statement is being submitted within three months of the filing date.

Each of the documents listed on the attached form equivalent to Form PTO-1449 is in the English language.

It is respectfully requested that this information disclosure statement be considered by the Examiner.

Please charge any shortage in the fees due in connection with the filing of this paper,  
including extension of time fees, to Deposit Account No. 01-2135 (219.40232X00) and please credit  
any excess fees to such deposit account.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Hung H. Bui". The signature is fluid and cursive, with the first name "Hung" being the most prominent.

Hung H. Bui

Registration No. 40,415

ANTONELLI, TERRY, STOUT & KRAUS, LLP

HHB/srm  
Attachments  
(703) 312-6600